### 505340587 02/22/2019

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Chung-Fu Chang	02/15/2019
Kuan-Hung Chen	02/21/2019
Guang-Yu Lo	02/15/2019
Chun-Chia Chen	02/15/2019
Chun-Tsen Lu	02/15/2019

### **RECEIVING PARTY DATA**

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Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park	
City:	Hsin-Chu City	
State/Country:	TAIWAN	

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16282323

### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	KATE YEH
SIGNATURE:	/KATE YEH/
DATE SIGNED:	02/22/2019

Total Attachments: 10 source=3397777#page1.tif source=3397777#page2.tif source=3397777#page3.tif

PATENT 505340587 REEL: 048403 FRAME: 0219



### Title of Invention:

# SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME

As the below named inventor, I here This declaration is directed to:	by declare that:		
☑ The attached application, or			
☐ United States application nu	ımber	filed on	, or
☐ PCT international applicatio	n number	filed on	
The above-identified application was	made or authorized to be made l	by me.	
I believe that I am the original invent application.	or or an original joint inventor of a	claimed invention in the	
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impr	I false statement made in this decisionment of not more than five (5)	elaration is punishable o years, or both.	
In consideration of the payment by	UNITED MICROELECTRON	IICS having a postal add	ress of
No.3, Li-Hsin Road 2, Science	-Based Industrial Park, Hsi	n-Chu City 300, Taiwan	, R.O.C.
(referred to as "ASSIGNEE"below) to acknowledged, and for other good are	o I of the sum of One Dollar (\$ 1.0 and valuable consideration.	0), the receipt of which is he	reby
I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.			
I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;			
I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal			
representatives any and all papers, i maintain, issue and enforce said app equivalents thereof which may be no IN WITNESS WHEREOF, I have her	plication, said invention and said Lacessary or desirable to carry out	etters Patent and said the proposes thereof.	
Note: An application data sheet (PTC inventive entity, must accompany thi	D/SB/14 or equivalent), including is some some some some some some some som	naming the entire	

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NPO#NAU-P3415-USA:0 CUST#UMCD-2018-0586

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor:

Chung-Fu Chang

Date:

FEB 1 5 2019

Signature:

Chang fur Chang

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F#NPO-P0002E-US1201 DSB0-107U037895

NPO#NAU-P3415-USA:0 CUST#UMCD-2018-0586

### Title of Invention:

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I further covenant that ASSIGNEE wand documents relating to said invented known and accessible to I and will terelated thereto and will promptly executed.	tion and said Letters Patent and I stify as to the same in any interfe	legal equivalents as may b	) <del>-</del>
representatives any and all papers, in maintain, issue and enforce said app equivalents thereof which may be ne IN WITNESS WHEREOF, I have her	lication, said invention and said L cessary or desirable to carry out	etters Patent and said	
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LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor:

**Kuan-Hung Chen** 

Date:

2019.02.

Signature:

Kuan-Hung Chen.

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F#NPO-P0002E-US1201 DSB0-107U037895 5

NPO#NAU-P3415-USA:0 CUST#UMCD-2018-0586

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NPO#NAU-P3415-USA:0 CUST#UMCD-2018-0586

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor:

Guang-Yu Lo

Date:

FEB 1 5 2019

Signature:

毅慶銀 Guang-Yu L

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F#NPO-P0002E-US1201 DSB0-107U037895

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representatives any and all papers, i maintain, issue and enforce said app equivalents thereof which may be ne IN WITNESS WHEREOF, I have her	plication, said invention and said Lecessary or desirable to carry out	Letters Patent and the proposes there	said eof
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LEGAL NAME OF INVENTOR(ASSIGNOR)				
Inventor:	Chun-Chia Chen	Date:	FEB 1 5 2019	
Signature:	Chun-Chia Chen			

Page 8 of 10

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LEGAL NAME OF INVENTOR(ASSIGNOR)					
Inventor:	Chun-Tsen Lu	Date:	FEB 1 5 2019		
Signature:	Chun-Teen Lu			_	

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**RECORDED: 02/22/2019** 

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